#### PATENT

### IN THE UNITED STATES PATENT AND TRADEMARK OFFICE

Applicants ; Chad A. Cobbley et al.

Serial No. : 10/077,554

Filing Date : February 15, 2002

For : Molded Stiffener For Thin Substrates

Examiner : TRINH, Hoa B.

Group Art Unit : 2814
Confirmation No. : 3265

#### CERTIFICATION OF SUBMISSION

I hereby certify that, on the date shown below, this correspondence is being transmitted via the Patent Electronic Filing System (EFS) addressed to Examiner TRINH at the U.S. Patent and Trademark Office.

Date: May 00, 2008

Commissioner for Patents

P.O. Box 1450 Alexandria, VA 22313-1450

## Communication re. Information Disclosure Statement

Sir:

Enclosed is a copy of an Information Disclosure Statement (IDS) that was filed electronically in the U.S. Patent and Trademark Office on July 22, 2005.

Also enclosed is a copy of the USPTO Acknowledgement Receipt indicating receipt of the IDS with a timestamp of 2005-07-22 10:06:45 EDT.

No fee is due for consideration of this item.

Applicant respectfully requests that the listed reference be made of record in the present application, and that an initialed copy of Form 1449 indicating consideration of this reference by the Examiner be returned to Applicant.

Respectfully submitted,

RPALMATO

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Dated: May 2 , 2008
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## ELECTRONIC INFORMATION DISCLOSURE STATEMENT

# Electronic Version v18 Stylesheet Version v18.0

Title of Invention

Molded Stiffener for Thin Substrates

Application Number:

10/077554

\*10/077554\*

Confirmation Number: 3265

First Named Applicant: Chad Cobbley Attorney Docket Number: MTI-31591

Art Unit: Examiner: 2814 Hoa B. Trinh

Search string:

( 6326544 or 6724071 ).pn.

## **US Patent Documents**

Note: Applicant is not required to submit a paper copy of cited US Patent Documents

Init	Cite.No.	Patent No.	Date	Patentee	Kind	Class	Subclass
	1	6326544	2001-12-04	Lake		174	52.2
	2	6724071	2004-04-20	Combs		257	666

# Signature

Examiner Name	Date

\*10/077554\*

## UNITED STATES PATENT AND TRADEMARK OFFICE ACKNOWLEDGEMENT RECEIPT

Electronic Version 1.1 Stylesheet Version v1.1.1

Title of Invention Molded Stiffener for Thin Substrates

Submission Type: Information Disclosure Statement

Application Number: 10/077554

EFS ID: 88676

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Confirmation Code	Message			
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First Named Applicant: Chad Cobbley Attorney Docket Number: MTI-31591

Timestamp: 2005-07-22 10:06:45 FDT

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Doc. Name	File Name	Size (Bytes)
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package-data	package-data.dtd	27025
package-data	us-package-data.xsl	19263
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